

#### 3.0mmx1.0mm RIGHT ANGLE SMD CHIP LED **LAMP**

Part Number: APBA3010SEKCGKC-GX

Super Bright Orange Green

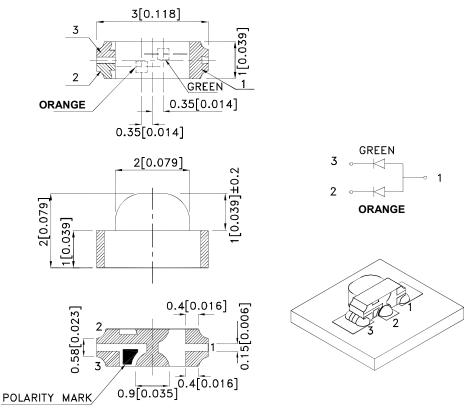
#### **Features**

- 3.0mmx2.0mmx1.0mm right angle SMD LED, 1.0mm thickness.
- Low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Package: 2000 pcs / reel.
- Moisture sensitivity level : level 3.
- Tinned pads for improved solderability
- RoHS compliant.

#### **Descriptions**

- The Super Bright Orange device is made with AlGaInP (on GaAs substrate) light emitting diode chip.
- The Green source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode.

### **Package Dimensions**



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.15(0.006") unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
   The device has a single mounting surface. The device must be mounted according to the specifications.

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#### **Selection Guide**

Part No.	Emitting Color (Material)	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
APBA3010SEKCGKC-GX	Super Bright Orange (AlGaInP)	Water Clear	120	320	140°
			*80	*150	
	Green (AlGaInP)		40	70	
			*40	*70	

- 1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
  2. Luminous intensity / luminous Flux: +/-15%.

  \* Luminous intensity value is traceable to CIE127-2007 standards.

### Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Emitting Color	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Super Bright Orange Green	610 574		nm	IF=20mA
λD [1]	Dominant Wavelength	Super Bright Orange Green	601 570		nm	I==20mA
Δλ1/2	Spectral Line Half-width	Super Bright Orange Green	29 20		nm	I==20mA
С	Capacitance	Super Bright Orange Green	15 15		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Super Bright Orange Green	2.1 2.1	2.5 2.5	V	I==20mA
lR	Reverse Current	Super Bright Orange Green		10 10	uA	V <sub>R</sub> = 5V

#### Notes:

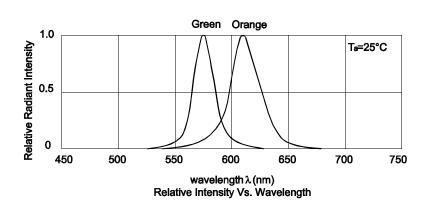
- 1. Wavelength: +/-1nm.
- 2. Forward Voltage: +/-0.1V.
- 3. Wavelength value is traceable to CIE127-2007 standards.
- 4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

#### Absolute Maximum Ratings at TA=25°C

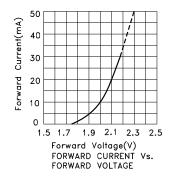
Parameter	Super Bright Orange	Green	Units		
Power dissipation	75	75	mW		
DC Forward Current	30	30	mA		
Peak Forward Current [1]	195	150	mA		
Reverse Voltage		V			
Operating Temperature	-40°C To +85°C				
Storage Temperature	-40°C To +85°C				

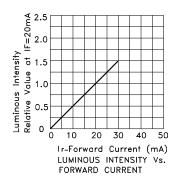
- Notes: 1. 1/10 Duty Cycle, 0.1ms Pulse Width.
- Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

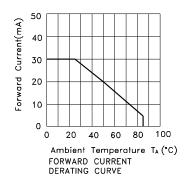
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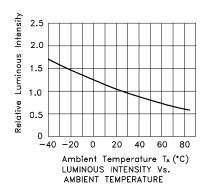


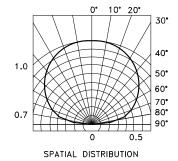
### APBA3010SEKCGKC-GX Super Bright Orange







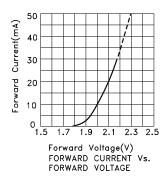


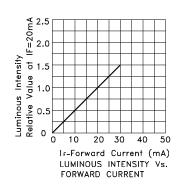


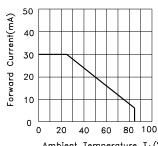
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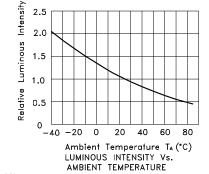
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### Green

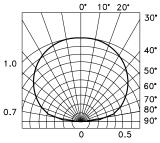












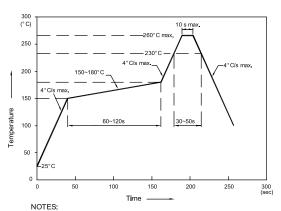
SPATIAL DISTRIBUTION

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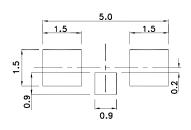
Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



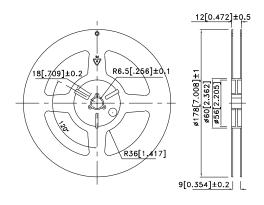
- 1. We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.
- 2.Don't cause stress to the epoxy resin while it is exposed
- to high temperature.
  3.Number of reflow process shall be 2 times or less.

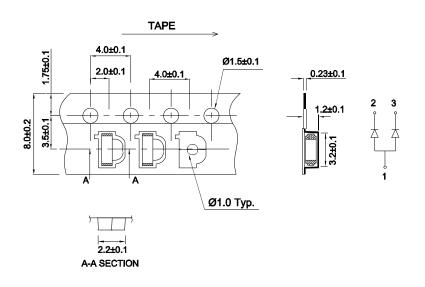
### Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



### Tape Dimensions (Units : mm)

### **Reel Dimension**



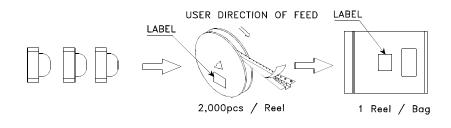


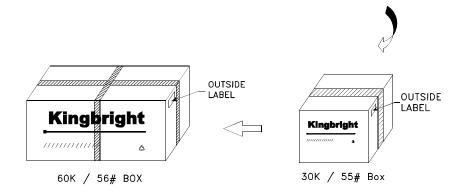
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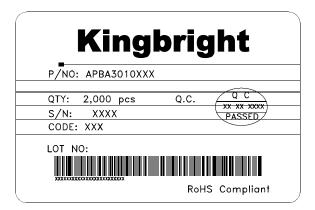
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#### **PACKING & LABEL SPECIFICATIONS**

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